



# Power MOSFETS

## DATASHEET

**LM1A160NAQ8A**

N-Channel  
Enhancement Mode MOSFET

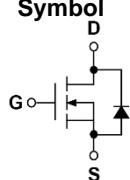
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Quality Management Systems  
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

### Pin Description

SOP-8L (TOP view)	Symbol	Symbol	N-Channel	Unit
		$V_{DSS}$	100	V
		$R_{DS(ON)-Max}$	15.6	mΩ
		$I_D$	7.5	A

### Feature

- Optimized high performance of  $R_{DS(on)}$  and  $Q_g$
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS Tested

### Ordering Information

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM1A160NAQ8A	SOP-8L	Tape & Reel	3000 / Tape & Reel	1A160 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note :      = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	100	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$I_{DM}^{(1)}$	Pulse Drain Current Tested	$T_A=25^\circ\text{C}$	A
$I_D$	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
$P_D$	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
$I_{AS}^{(2)}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	A
		$L=0.5\text{mH}$	
$E_{AS}^{(2)}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	mJ
		$L=0.5\text{mH}$	

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{θJA}^{(3)}$	Thermal Resistance-Junction to Ambient	Steady State	78

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $150^\circ\text{C}$

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_{DS}=250\mu\text{A}$	100	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=80\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu\text{A}$	1	2	3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
$R_{DS(\text{ON})}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{GS}=10\text{V}, I_{DS}=8\text{A}$	-	13	15.6	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_{DS}=6\text{A}$	-	20	26	
$g_{fs}$	Forward Transconductance	$V_{DS}=5\text{V}, I_{DS}=8\text{A}$	-	15.5	-	S
<b>Dynamic Characteristics <sup>(5)</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V},$ Freq.=1MHz	-	3	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V},$ $V_{DS}=50\text{V},$ Freq.=1MHz	-	1058	-	$\text{pF}$
$C_{oss}$	Output Capacitance		-	185	-	
$C_{rss}$	Reverse Transfer Capacitance		-	5	-	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{GS}=10\text{V}, V_{DS}=50\text{V},$ $I_D=1\text{A}, R_{GEN}=3\Omega$	-	6	-	$\text{nS}$
$t_r$	Turn-on Rise Time		-	15	-	
$t_{d(\text{OFF})}$	Turn-off Delay Time		-	16	-	
$t_f$	Turn-off Fall Time		-	25	-	
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=50\text{V}$ $I_D=12\text{A}$	-	12.8	-	$\text{nC}$
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=50\text{V},$ $I_D=12\text{A}$	-	22.5	-	
$Q_{gs}$	Gate-Source Charge		-	3.2	-	
$Q_{gd}$	Gate-Drain Charge		-	7.7	-	
<b>Source-Drain Characteristics</b>						
$V_{SD}^{\text{(4)}}$	Diode Forward Voltage	$I_{SD}=8\text{A}, V_{GS}=0\text{V}$	-	0.8	1.1	V
$t_{rr}$	Reverse Recovery Time	$I_F=20\text{A}, V_R=50\text{V}$	-	40	-	$\text{nS}$
$Q_{rr}$	Reverse Recovery Charge		-	58.7	-	$\text{nC}$

Note <sup>(4)</sup> : Pulse test (pulse width $\leq 300\text{us}$ , duty cycle $\leq 2\%$ ).Note <sup>(5)</sup> : Guaranteed by design, not subject to production testing.

## N-Channel Typical Characteristics

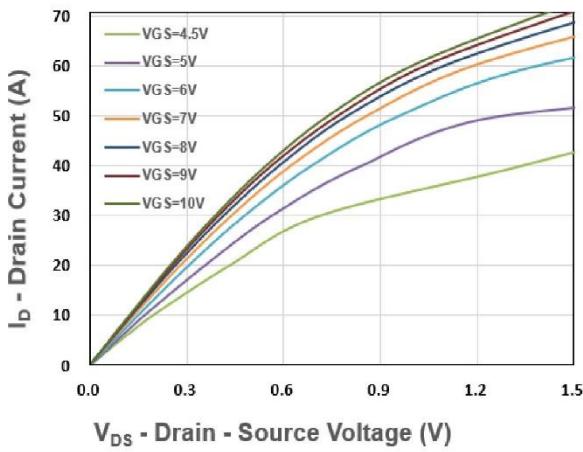


Figure 1. Output Characteristics

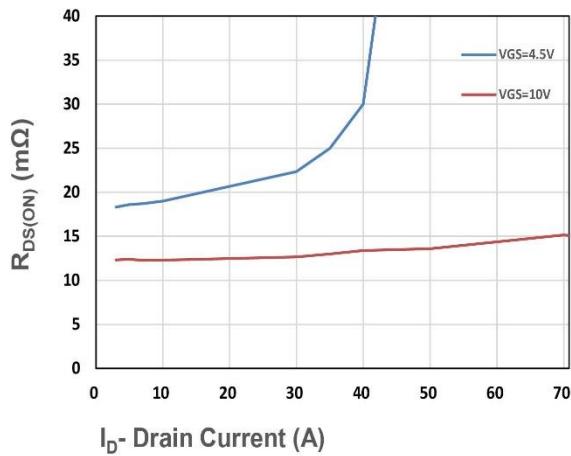


Figure 2. On-Resistance vs. ID

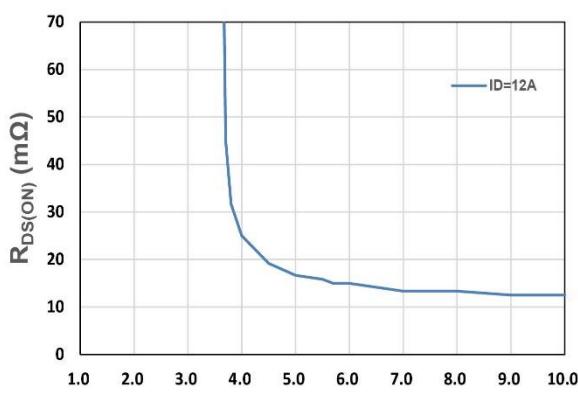


Figure 3. On-Resistance vs. VGS

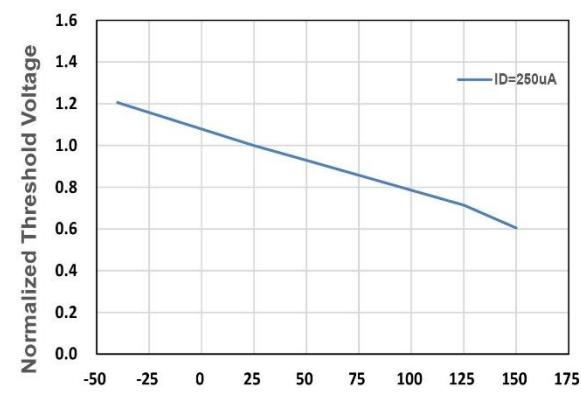


Figure 4. Gate Threshold Voltage

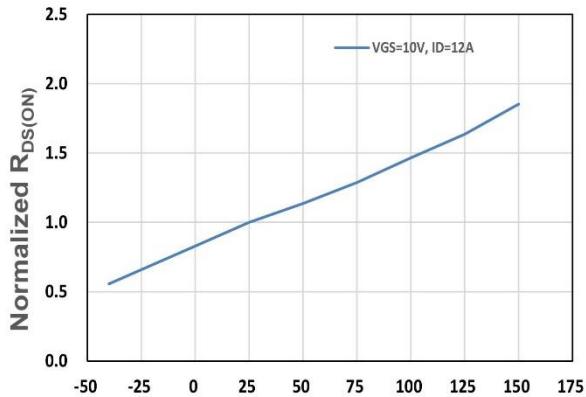


Figure 5. Drain-Source On Resistance

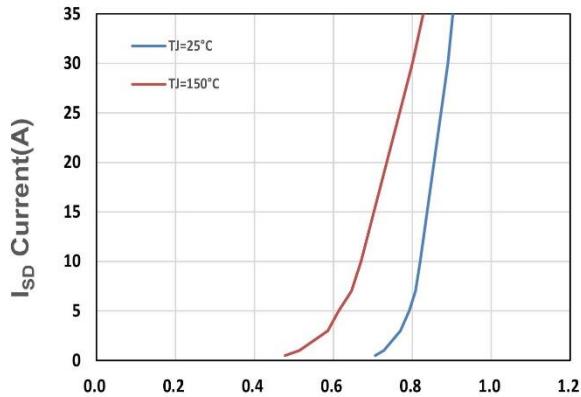
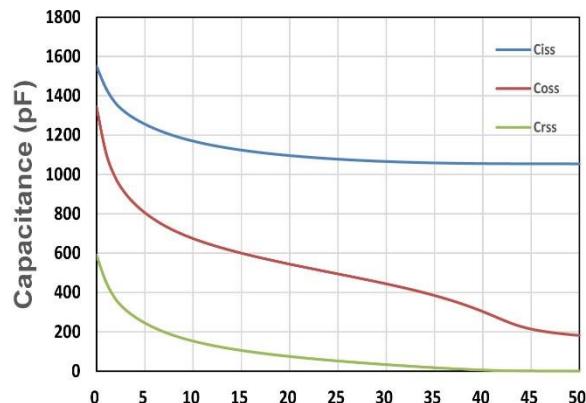
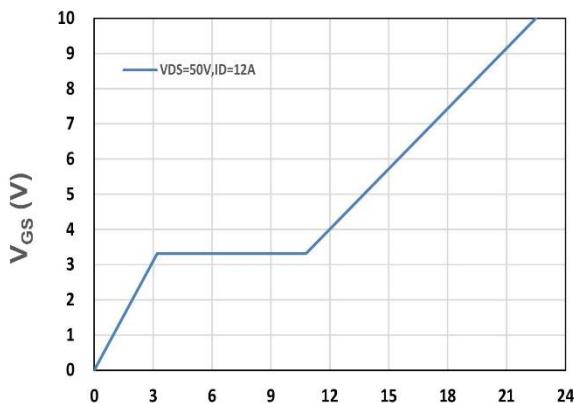


Figure 6. Source-Drain Diode Forward

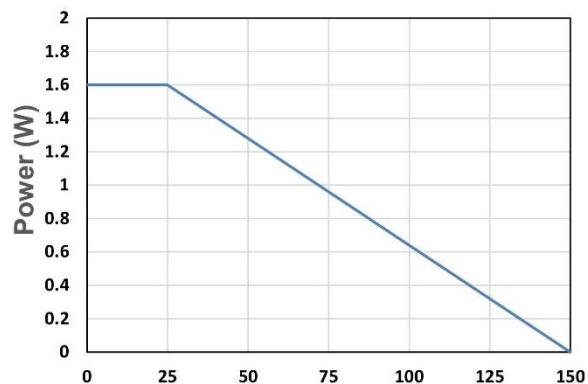
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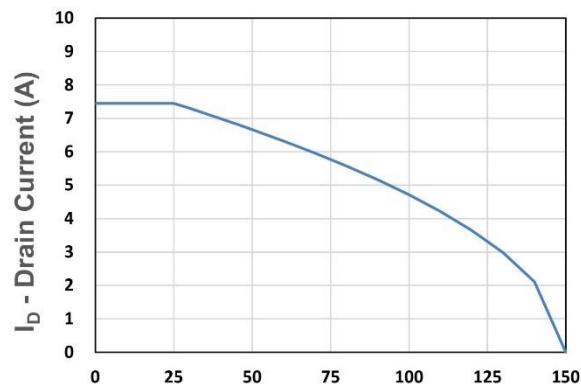
$V_{DS}$  - Drain - Source Voltage (V)  
Figure 7. Capacitance



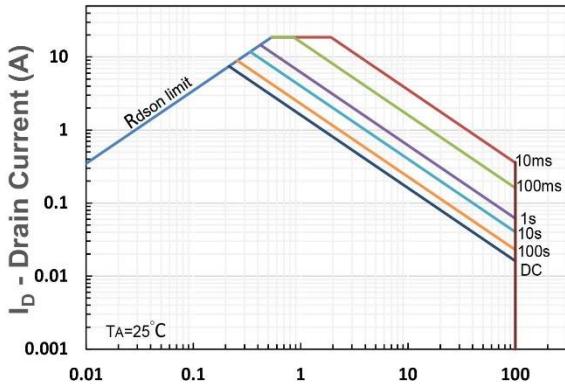
$Q_g$ , Total Gate Charge (nC)  
Figure 8. Gate Charge Characteristics



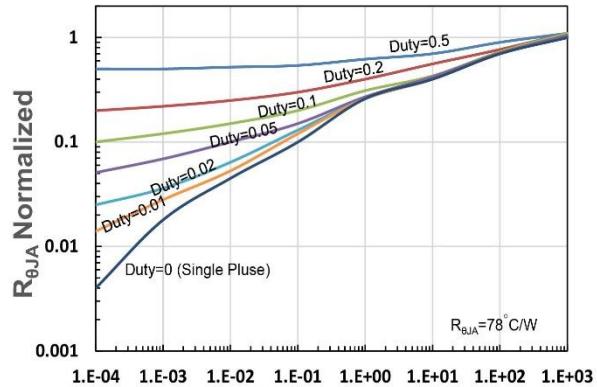
$T_j$  - Ambient Temperature (°C)  
Figure 9. Power Dissipation



$T_j$  - Ambient Temperature (°C)  
Figure 10. Drain Current



$V_{DS}$  - Drain-Source Voltage (V)  
Figure 11. Safe Operating Area



$t_1$ , Square Wave Pulse Duration(s)  
Figure 12.  $R_{θJA}$  Transient Thermal Impedance